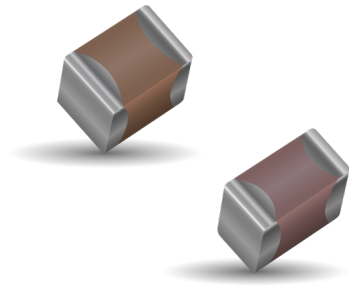


01005 MLCC Ultra Miniature Capacitors

General Specifications

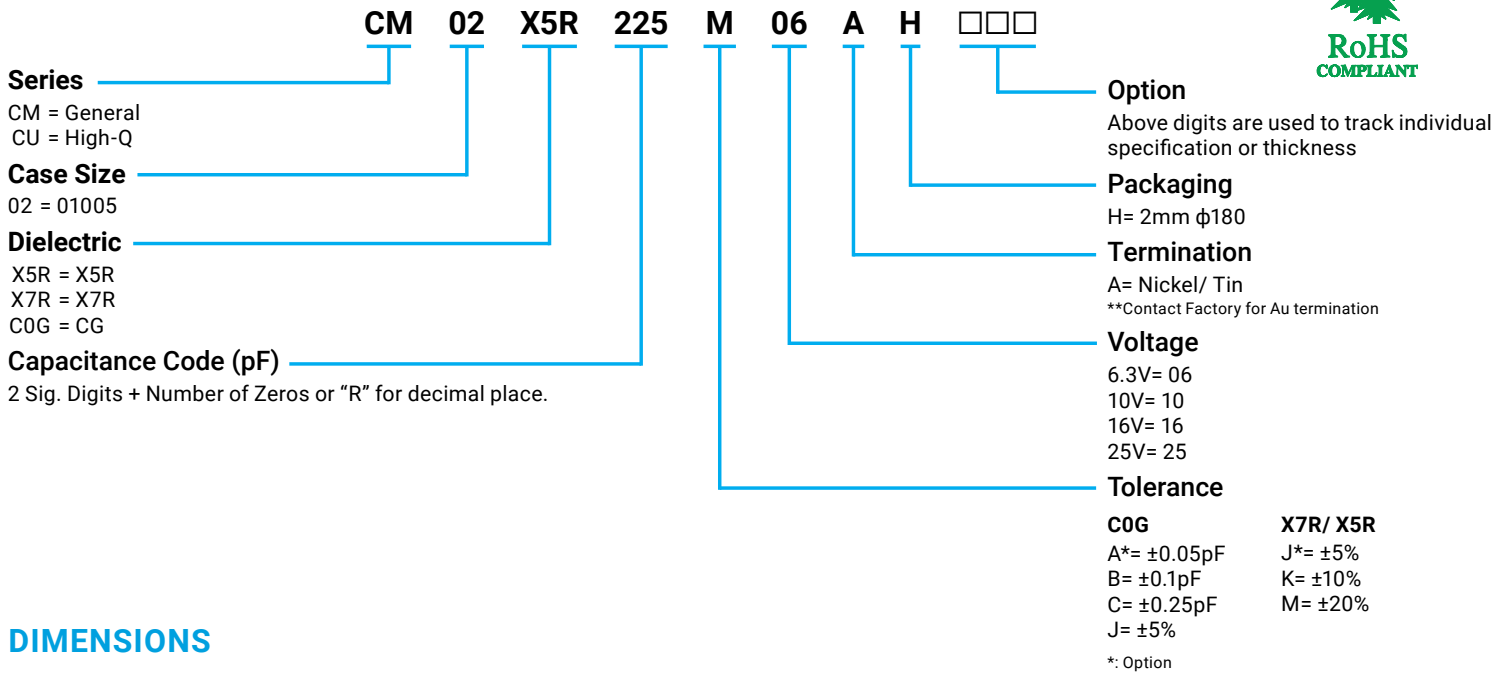


GENERAL DESCRIPTION

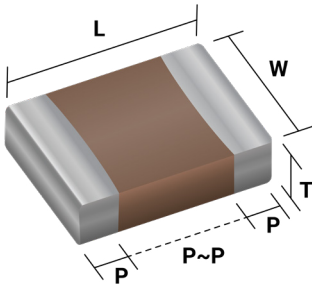
Offered in a complete range of products for both general and specialized applications and designed to meet a wide variety of needs. We have a worldwide network in order to supply our global customer bases quickly and efficiently. All of our products are highly reliable due to their monolithic structure of high-purity and superfine uniform ceramics and their integral internal electrodes.

Using Kyocera's latest manufacturing technology and materials with high dielectric constants, we produce extremely compact components with exceptional specifications. Our stringent quality control in every phase of production from material procurement to shipping ensures consistent manufacturing and superior quality.

HOW TO ORDER



DIMENSIONS



PACKAGING CODE

| 20kp | P | | 8 | | 2 | |
|--------|-----------------|----------|--------------|-------|-------|-------|
| 100Pcs | Taping Material | | Taping Width | | Pitch | |
| | Code | Material | Code | Width | Code | Width |
| | P | Paper | 8 | 8 mm | 2 | 2 mm |

| Size | Code | | Dimension Code | Dimension (mm) | | | | | | Quantity per reel |
|------|-------|------|----------------|----------------|----------------|----------------|--------|--------|-------------|-------------------|
| | EIA | JIS | | L | W | T | P min. | P max. | P to P min. | |
| 02 | 01005 | 0402 | A | 0.4 \pm 0.02 | 0.2 \pm 0.02 | 0.2 \pm 0.02 | 0.07 | 0.14 | 0.13 | 20kp(P8/2) |

01005 MLCC Ultra Miniature Capacitors

General Specifications

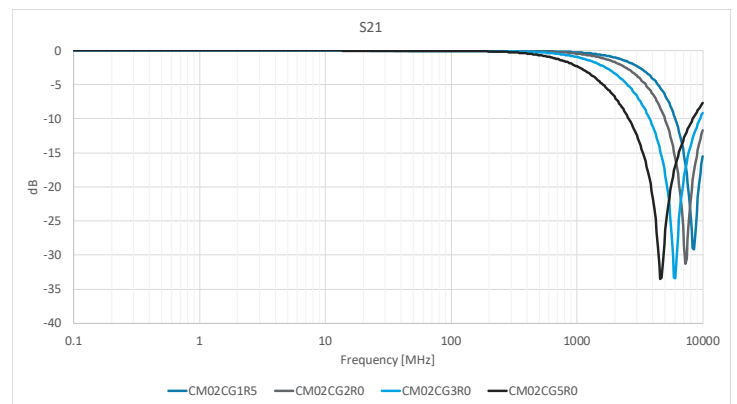
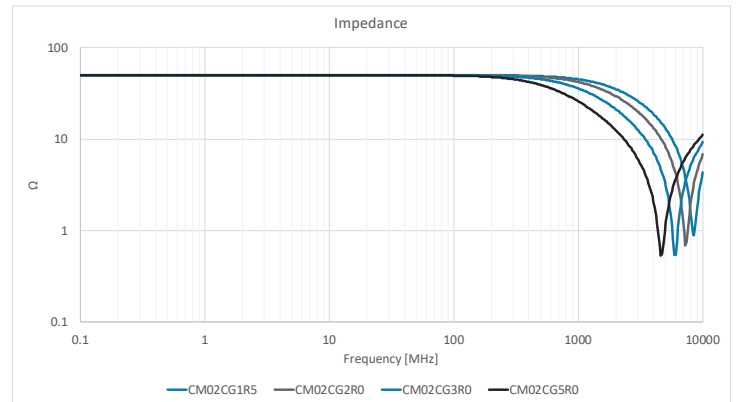
COG / NP0 DIELECTRIC

| Size (EIA Code) | | CM02 (01005) | | | | | |
|---------------------|-----|--------------|---------|-----|--------|---------|-----|
| Rated Voltage (Vdc) | | 16 | | | 25 | | |
| Tolerance | | B | C | J | B | C | J |
| Capacitance (pF) | | ±0.1pF | ±0.25pF | ±5% | ±0.1pF | ±0.25pF | ±5% |
| R20 | 0.2 | | | | | | |
| R50 | 0.5 | | | | | A | |
| 1R0 | 1.0 | | | | A | | |
| 1R5 | 1.5 | A | | | | | |
| 2R0 | 2.0 | | | | A | | |
| 3R0 | 3.0 | | A | | | | |
| 4R0 | 4.0 | | | | | A | |
| 5R0 | 5.0 | | | | | | |
| 6R0 | 6.0 | | | | | | |
| 7R0 | 7.0 | | | | | | |
| 8R0 | 8.0 | | | | | | |
| 9R0 | 9.0 | | | | | | |
| 100 | 10 | | | | | | A |
| 120 | 12 | | | | | | |
| 150 | 15 | | | A | | | |
| 180 | 18 | | | | | | A |
| 220 | 22 | | | | | | |
| 270 | 27 | | | | | | |
| 330 | 33 | | | | | | |
| 390 | 39 | | | | | | |
| 470 | 47 | | | A | | | |
| 560 | 56 | | | | | | |
| 680 | 68 | | | | | | |
| 820 | 82 | | | | | | |
| 101 | 100 | | | | | | |
| 121 | 120 | | | | | | |
| 151 | 150 | | | | | | |
| 181 | 180 | | | | | | |
| 221 | 220 | | | A | | | |

< Standard Capacitor Value: E12 Series >

*Please Contact for capacitance values other than standard

CU Series
 CM Series
 CM & CU Series



COG / NP0 CAP CHART: Alphabets denotes dimensions.

Please refer to the below table for details.

| Size | Dimension Code | Dimension (mm) | | | Packaging | | | | |
|------|----------------|----------------|----------|----------|------------|----------|-----------------|--------------|--------------|
| | | L | W | T | φ 180 Reel | | | | |
| | | | | | Code | Quantity | Taping Material | Taping Width | Cavity Pitch |
| 02 | A | 0.4±0.02 | 0.2±0.02 | 0.2±0.02 | H | 20,000 | Paper | 8mm | 2mm |


01005 MLCC Ultra Miniature Capacitors


General Specifications

X5R DIELECTRIC

| Size (EIA Code) | | CM02 (01005) | | | | |
|---------------------|----------|--------------|------|------|------|------|
| Rated Voltage (Vdc) | | 6.3 | | 10 | 16 | |
| Tolerance | | K | M | M | K | M |
| Capacitance | | ±10% | ±20% | ±20% | ±10% | ±20% |
| 101 | 100 pF | | | | A8 | A8 |
| 151 | 150 pF | | | | | |
| 221 | 220 pF | | | | | |
| 331 | 330 pF | | | | | |
| 471 | 470 pF | | | | | |
| 681 | 680 pF | | | | | |
| 102 | 1000 pF | | | | | |
| 152 | 1500 pF | | | | | |
| 222 | 2200 pF | | | | | |
| 472 | 4700 pF | | | | | |
| 682 | 6800 pF | | | | | |
| 103 | 10000 pF | | | | | |
| 153 | 15000 pF | A8 | A8 | | | |
| 223 | 22000 pF | | | | | |
| 333 | 33000 pF | | | | | |
| 473 | 47000 pF | | | | | |
| 104 | 0.10 μF | | | A8 | | |
| 224 | 0.22 μF | A8 | A8 | | | |
| 474 | 0.47 μF | | A8 | | | |
| 105 | 1.0 μF | | | | | |
| 225 | 2.2 μF | | | | | |
| 475 | 4.7 μF | | | | | |
| 106 | 10 μF | | | | | |
| 156 | 15 μF | | | | | |
| 226 | 22 μF | | | | | |

< Standard Capacitor Value>
Cap Value < 0.1 μF: E6 Series
Cap value ≥ 0.1 μF: E3 Series

 CM Standard Spec. 1


 CM Standard Spec. 2

| X5R Tan δ Code | Tan δ |
|----------------|------------|
| 3 | 5.0% max. |
| 4 | 7.0% max. |
| 5 | 7.5% max. |
| 7 | 10.0% max. |
| 8 | 12.5% max. |
| 9 | 15.0% max. |
| 10 | 20.0% max. |

X7R DIELECTRIC

| Size (EIA Code) | | CM02 (01005) |
|---------------------|---------|--------------|
| Rated Voltage (Vdc) | | 16 |
| Capacitance | | |
| 101 | 100 pF | |
| 151 | 150 pF | |
| 221 | 220 pF | |
| 331 | 330 pF | |
| 471 | 470 pF | |
| 681 | 680 pF | |
| 102 | 1000 pF | |
| 152 | 1500 pF | |
| 222 | 2200 pF | A8 |

< Standard Capacitor Value>
Cap Value < 0.1 μF: E6 Series

 CM Standard Spec. 1

| X7R Tan δ Code | Tan δ |
|----------------|------------|
| 2 | 3.5% max. |
| 3 | 5.0% max. |
| 5 | 7.5% max. |
| 8 | 12.5% max. |

X7R/ X5R CAP CHART: Two digit denotes dimensions and tan δ code

Please refer to the below table for detail.

| Size | Dimension Code | Dimension (mm) | | | Packaging | | | | |
|------|----------------|----------------|----------|----------|------------|----------|-----------------|--------------|--------------|
| | | L | W | T | φ 180 Reel | | | | |
| | | | | | Code | Quantity | Taping Material | Taping Width | Cavity Pitch |
| 02 | A | 0.4±0.02 | 0.2±0.02 | 0.2±0.02 | H | 20,000 | Paper | 8mm | 2mm |

01005 MLCC Ultra Miniature Capacitors

CM/CU (Standard Spec. 1) Specifications and Test Methods



| Test Items | | Test Conditions | | | Specifications | | | | | | | | | |
|----------------------------|--|---|------------|--|--|-------------|------|---|----------|-------|---|-----------|-------|--|
| Capacitance Value (C) | | Capacitance | Frequency | Volt | Within Tolerance | | | | | | | | | |
| Q | | C _≥ 1000pF | 1 MHz ±10% | 0.5 to 5 Vrms | "C _≥ 30pF : Q _≥ 1000 C<30pF : Q _≥ 400+20C" | | | | | | | | | |
| | | C _≤ 1000pF | 1 kHz ±10% | | | | | | | | | | | |
| Insulation Resistance (IR) | | Apply the rated voltage for 1 minute, and measure it in normal temperature and humidity. The charge and discharge current of the capacitor must not exceed 50mA. | | | Over 10000MΩ or 500MΩnμF, whichever is less. | | | | | | | | | |
| Dielectric Resistance | | Apply *3 times the rated voltage for 1 to 5 seconds twice. The charge and discharge current of the capacitor must not exceed 50mA. *CU02CΔR20-120/25V: twice | | | No defect | | | | | | | | | |
| Appearance | | Microscope | | | No defect | | | | | | | | | |
| Termination Strength | | Apply a sideward force of 100g (1N) to PCB-mounted sample. | | | No defect | | | | | | | | | |
| Bending Strength | | Glass epoxy PCB: Fulcrum spacing: 90mm, duration time 10 Seconds. | | | No Significant damage with 1mm bending. | | | | | | | | | |
| Vibration Test | Appearance | "Vibration Frequency: 10-55 (Hz) Amplitude: 1.5mm Sweeping Condition: 10 → 55 → 10 Hz/ 1 minute in X, Y and Z Directions: 2 hours each, 6 hours total" | | | No defect | | | | | | | | | |
| | Δ C | | | | Within Tolerance | | | | | | | | | |
| | Q | | | | "C _≥ 30pF : Q _≥ 1000 C<30pF : Q _≥ 400+20C" | | | | | | | | | |
| Soldering Heat Resistant | Appearance | "Soak the Sample in 260°C ± 5°C solder for 10±0.5 seconds and place in normal temperature and humidity. Measure the sample after 24± 2 hours. (Pre-heating conditions) | | | No defect | | | | | | | | | |
| | Δ C | | | | Within ± 2.5% or ± 0.25 pF, whichever is larger | | | | | | | | | |
| | Q | <table border="1"> <thead> <tr> <th>Order</th> <th>Temperature</th> <th>Time</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>80-100°C</td> <td>2 min</td> </tr> <tr> <td>2</td> <td>150-200°C</td> <td>2 min</td> </tr> </tbody> </table> | | | Order | Temperature | Time | 1 | 80-100°C | 2 min | 2 | 150-200°C | 2 min | "C _≥ 30pF : Q _≥ 1000 C<30pF : Q _≥ 400+20C" |
| | Order | Temperature | Time | | | | | | | | | | | |
| | 1 | 80-100°C | 2 min | | | | | | | | | | | |
| 2 | 150-200°C | 2 min | | | | | | | | | | | | |
| IR | | | | Over 10000MΩ or 500MΩnμF, whichever is less. | | | | | | | | | | |
| Withstanding Voltage | The charge and discharge current of the capacitor must not exceed 50mA for IR and Withstanding Voltage measurement." | | | Resist without problem | | | | | | | | | | |
| Solderability | | Soak Condition: | | | Solder Coverage : 95% min. | | | | | | | | | |
| | | Sn-3AG-0.5Cu | 245 ±5°C | 3 ±0.5 sec. | | | | | | | | | | |
| | | Sn63 Solder | 235 ±5°C | 2 ±0.5 sec. | | | | | | | | | | |
| Temperature Cycle | Appearance | (Cycle) | | | No defect | | | | | | | | | |
| | Δ C | Room Temperature (3min.) → Lowest Operating Temperature (30 min.) → Room Temperature (3 min.) → Highest Operating Temperature (30 min.) | | | Within ± 2.5% or ± 0.25 pF, whichever is larger | | | | | | | | | |
| | Q | | | | "C _≥ 30pF : Q _≥ 1000 C<30pF : Q _≥ 400+20C" | | | | | | | | | |
| | IR | After 5 cycles, measure after 24 ± 2 hours. | | | Over 10000MΩ or 500MΩnμF, whichever is less. | | | | | | | | | |
| | Withstanding Voltage | The charge and discharge current of the capacitor must not exceed 50mA for IR and Withstanding Voltage measurement." | | | Resist without problem | | | | | | | | | |
| Moisture Resistant Load | Appearance | After applying the rated voltage for 500-512 hours in the condition of 40°C± 2°C and 90 to 95% RH, allow the parts to stabilize in normal temperature and humidity for 24 ± 2 hours, before measurement. | | | No defect | | | | | | | | | |
| | Δ C | | | | Within ± 7.5% or ± 0.75 pF, whichever is larger | | | | | | | | | |
| | Q | The charge and discharge current of the capacitor must not exceed 50mA for IR measurement. | | | "C _≥ 30pF : Q _≥ 200 C<30pF : Q _≥ 100+10C/3" | | | | | | | | | |
| | IR | | | | Over 500MΩ or 25MΩnμF, whichever is less. | | | | | | | | | |
| High-Temperature Load | Appearance | | | | No defect | | | | | | | | | |
| | Δ C | After applying *twice the rated voltage in the condition of 125±3°C for 1000-1012 hours, measure the sample after 24 ± 2 hours in normal temperature and humidity. The charge and discharge current of the capacitor must not exceed 50mA for IR measurement. | | | Within ± 3% or ± 0.3 pF, whichever is larger | | | | | | | | | |
| | Q | ** Applied voltages for respective products are indicated in the chart below. | | | C _≥ 30pF : Q _≥ 350 10pF<C<30pf : Q _≥ 275+5C/2 C<10pF : Q _≥ 200+10C | | | | | | | | | |
| | IR | | | | Over 1000MΩ or 50MΩnμF, whichever is less. | | | | | | | | | |

Please Ask for individual specification for the hatched range in previous chart.
Voltage to be applied in the High Temperature Load (Applied Voltage is the multiple of the rated voltage)

| Applied Voltage | Rated Voltage | Products |
|-----------------|---------------|---------------|
| X 1.0 | 16V | CM02CΔ221 |
| X 1.2 | 24V | CM02CΔR20-120 |

01005 MLCC Ultra Miniature Capacitors

CM Series (Standard Spec. 1 & 2) Specifications and Test Methods



| Test Items | | Test Conditions | | Specifications Standard Spec. 1 | Specifications Standard Spec. 2 | | | | | | | | |
|----------------------------|----------------------|--|----------------------------|--|---|----------------------------|-------------|----------------------------|--------------|----------------------------|----------------------------|-------|------------------------|
| Capacitance Value (C) | | Measure after heat treatment | | Within Tolerance | Within Tolerance | | | | | | | | |
| Tan δ | Spec. 1 | | Spec. 2 | | Refer to capacitance chart | Refer to capacitance chart | | | | | | | |
| | Capacitance | Frequency | Volt | Capacitance | | | Frequency | Volt | | | | | |
| | C≤10 μF | 1 kHz ± 10% | 1.0 ± 0.2 V _{rms} | C≤10 μF | | | 1 kHz ± 10% | 1.0 ± 0.2 V _{rms} | | | | | |
| | C≤10 μF | 120 Hz ± 10% | 0.5 ± 0.2 V _{rms} | C>10 μF | 120 Hz ± 10% | 0.5 ± 0.2 V _{rms} | | | | | | | |
| | | The charge and discharge current of the capacitor must not exceed 50mA. | | | | | | | | | | | |
| Insulation Resistance (IR) | | Apply the rated voltage for 1 minute, and measure it in normal temperature and humidity. The charge and discharge current of the capacitor must not exceed 50mA. | | Over 10000MΩ or 500MΩ·μF, whichever is less. | Over 50MΩ·μF | | | | | | | | |
| Dielectric Resistance | | Apply 2.5 times the rated voltage for 1-5 seconds. The charge and discharge current of the capacitor must not exceed 50mA. | | No defect | No defect | | | | | | | | |
| Appearance | | Microscope | | No defect | No defect | | | | | | | | |
| Termination Strength | | Apply a sideways force of 100g (1N) to PCB-mounted sample. | | No defect | No defect | | | | | | | | |
| Bending Strength | | Glass epoxy PCB: Fulcrum spacing: 90mm, duration time 10 seconds. | | No Significant damage with 1mm bending. | No Significant damage with 1mm bending. | | | | | | | | |
| Vibration Test | Appearance | Take the initial value after heat treatment. Vibration Frequency: 10-55 (Hz) Amplitude: 1.5mm Sweeping Condition: 10_55_10 Hz/ 1 minute in X, Y and Z Directions: 2 hours each, 6 hours total, and place in normal temperature and humidity. Measure the sample after heat treatment. | | No defect | No defect | | | | | | | | |
| | Δ C | | | Within Tolerance | Within Tolerance | | | | | | | | |
| | Tan δ | | | Within Tolerance | Within Tolerance | | | | | | | | |
| Soldering Heat Resistant | Appearance | Take the initial value after heat treatment. | | No defect | No defect | | | | | | | | |
| | Δ C | Soak the Sample in 260°C ± 5°C solder for 10±0.5 seconds and place in normal temperature and humidity. | | Within ± 7.5% | Within ± 7.5% | | | | | | | | |
| | Tan δ | Measure after heat treatment. (Pre-heating conditions) | | Within Tolerance | Within Tolerance | | | | | | | | |
| | IR | | | Over 10000MΩ or 500MΩ·μF, whichever is less. | Over 50MΩ·μF | | | | | | | | |
| | Withstanding Voltage | <table border="1"> <thead> <tr> <th>Order</th> <th>Temperature</th> <th>Time</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>80-100°C</td> <td>2 min</td> </tr> <tr> <td>2</td> <td>150-200°C</td> <td>2 min</td> </tr> </tbody> </table> <p>The charge and discharge current of the capacitor must not exceed 50mA for IR and Withstanding Voltage measurement.</p> | | Order | Temperature | Time | 1 | 80-100°C | 2 min | 2 | 150-200°C | 2 min | Resist without problem |
| Order | Temperature | Time | | | | | | | | | | | |
| 1 | 80-100°C | 2 min | | | | | | | | | | | |
| 2 | 150-200°C | 2 min | | | | | | | | | | | |
| Solderability | | Soak Condition: <table border="1"> <thead> <tr> <th>Sn-3AG-0.5Cu</th> <th>245 ± 5°C</th> <th>3 ± 0.5 sec.</th> </tr> </thead> <tbody> <tr> <td>Sn63 Solder</td> <td>235 ± 5°C</td> <td>3 ± 0.5 sec.</td> </tr> </tbody> </table> | | Sn-3AG-0.5Cu | 245 ± 5°C | 3 ± 0.5 sec. | Sn63 Solder | 235 ± 5°C | 3 ± 0.5 sec. | Solder Coverage : 90% min. | Solder Coverage : 90% min. | | |
| Sn-3AG-0.5Cu | 245 ± 5°C | 3 ± 0.5 sec. | | | | | | | | | | | |
| Sn63 Solder | 235 ± 5°C | 3 ± 0.5 sec. | | | | | | | | | | | |
| Temperature Cycle | Appearance | Take initial value after heat treatment. | | No defect | No defect | | | | | | | | |
| | Δ C | (Cycle) Room Temperature (3min.) | | Within ± 7.5% | Within ± 7.5% | | | | | | | | |
| | Tan δ | Lowest Operating Temperature (30 min.) | | Within Tolerance | Within Tolerance | | | | | | | | |
| | IR | Room Temperature (3 min.) | | Over 10000MΩ or 500MΩ·μF, whichever is less. | Over 50MΩ·μF | | | | | | | | |
| | Withstanding Voltage | Highest Operating Temperature (30 min.) After 5 cycles, measure after heat treatment. The charge and discharge current of the capacitor must not exceed 50mA for IR and Withstanding Voltage measurement. | | Resist without problem | Resist without problem | | | | | | | | |
| Moisture Resistant Load | Appearance | Take the initial value after heat treatment. After applying the rated voltage for 500-512 hours in the condition of 40°C± 2°C and 90 to 95% RH, place in normal temperature and humidity, then measure the sample after heat treatment. The charge and discharge current of the capacitor must not exceed 50mA for IR measurement. | | No defect | No defect | | | | | | | | |
| | Δ C | | | Within ± 12.5% | Within ± 12.5% | | | | | | | | |
| | Tan δ | | | 200% max. of initial value | 200% max. of initial value | | | | | | | | |
| | IR | | | Over 500MΩ or 25MΩ·μF, whichever is less. | Over 10MΩ·μF | | | | | | | | |
| High-Temperature Load | Appearance | Take the initial value after heat treatment. After applying *twice the rated voltage in the highest operating temperature for 1000-1012 hours, measure the sample after heat treatment in normal temperature and humidity. The charge and discharge current of the capacitor must not exceed 50mA for IR measurement. | | No defect | No defect | | | | | | | | |
| | Δ C | | | Within ± 12.5% | Within ± 12.5% | | | | | | | | |
| | Tan δ | | | 200% max. of initial value | 200% max. of initial value | | | | | | | | |
| | IR | *X5R Spec 2: Apply 1.0 times when the rated voltage is 4V or less. X7R/X7R Spec 1: Apply 1.5 times when the rated Voltage is 10V or less. Applied Voltages for respective products are indicated in the chart below. | | Over 1000MΩ or 50MΩ·μF, whichever is less. | Over 10MΩ·μF | | | | | | | | |
| Heat Treatment | | Expose sample to temperature of 140-150°C for 1 hour and leave the sample in normal temperature and humidity for 24 ± 2 hours. | | | | | | | | | | | |

Voltage to be applied in the High Temperature Load (Applied Voltage is the multiple of the rated voltage)

| Applied Voltage | Rated Voltage | Products |
|-----------------|---------------|----------------------------|
| X1.0 | 10V | CM02X5R104 |
| X1.3 | 6.3V | CM02X5R153-104 |
| X1.5 | 16V | CM02X5R101-103, CM02X7R222 |

| Applied Voltage | Rated Voltage | Products |
|-----------------|---------------|------------------------|
| X1.0 | 6.3V | CM02X5R224, CM02X5R474 |

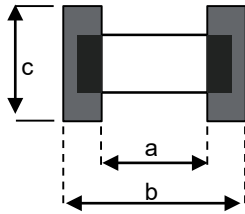


The Important Information/Disclaimer is incorporated in the catalog where these specifications came from or available online at www.avx.com/disclaimer/ by reference and should be reviewed in full before placing any order.

01005 MLCC Ultra Miniature Capacitors

Test Conditions and Standards

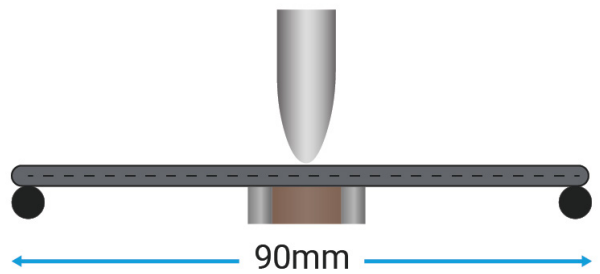
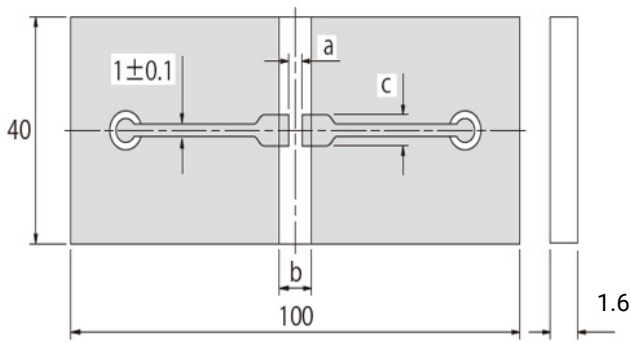
Substrate for Adhesion Strength Test, Vibration Test, Soldering Heat Resistance Test, Temperature Cycle Test, Load Humidity Test, High-Temperature with Loading Test.



Unit: mm

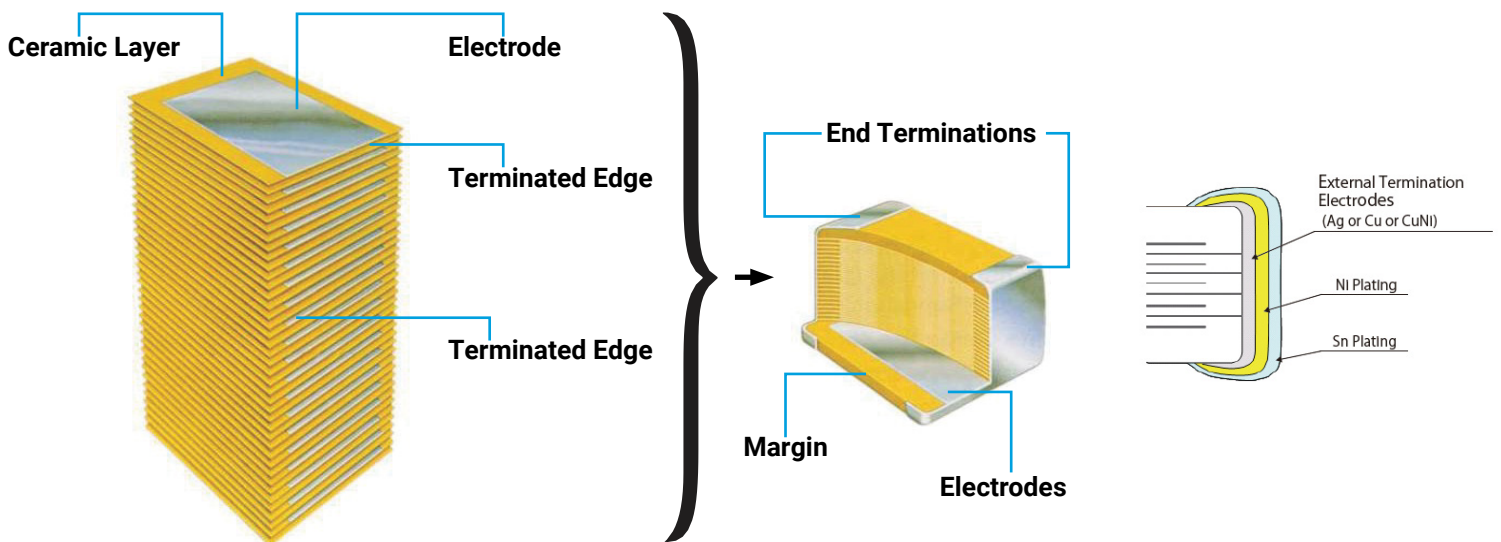
| Size (EIA Code) | A | B | C |
|-----------------|------|-----|------|
| 02 (01005) | 0.15 | 0.5 | 0.20 |

SUBSTRATE FOR BENDING TEST



Testing Board: Glass Epoxy Board (CE4 or FR4)
 Testing Board Thickness: 1.6 ± 0.2mm*
 Circuit Thickness: 0.04 ± 0.01mm

STRUCTURE

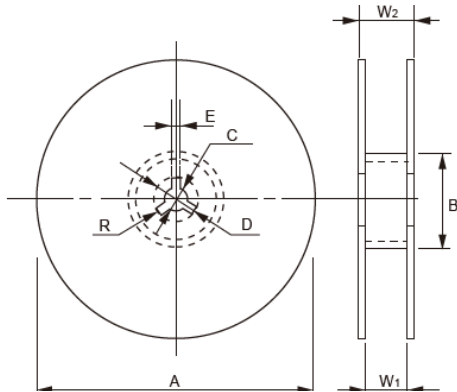


- Please contact your local AVX Sales office or distributor for specifications not covered in this catalog.
- Capacitance range is subject to change without notice
- Please contact sales representative to confirm compatibility with your application.

01005 MLCC Ultra Miniature Capacitors

Packaging Options

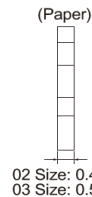
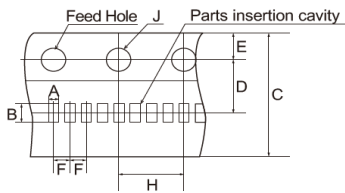
TAPE & REEL QUANTITIES



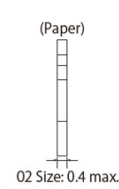
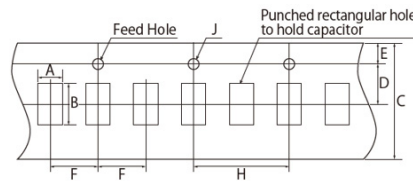
| Code Reel | A | B | C | D |
|------------------------|-------------------------------------|----------------|----------------|---------|
| 7- inch Reel (Code: H) | 180 ⁺⁰ / _{-2.0} | φ 60 min. | 13 ±0.5 | 21 ±0.8 |
| Code Reel | E | W ₁ | W ₂ | R |
| 7- inch Reel (Code: H) | 2.0 ±0.5 | 10.5 ±1.5 | 16.5 max. | 1.0 |

CARRIER TAPE

F = 1mm

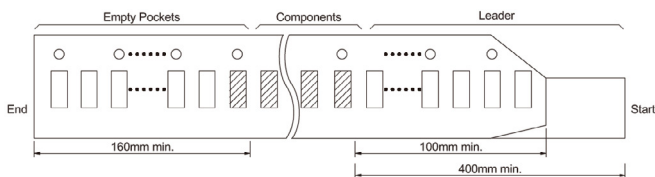


F = 2mm



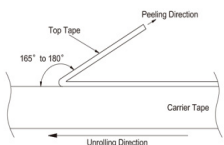
| Size (EIA Code) | A | B | C | D | E | F | G | H | J | Carrier Tape | |
|-----------------|-------------|-------------|-----------|------------|------------|------------|---|-----------|-----------|--------------|----------|
| | | | | | | | | | | Width | Material |
| 02 (01005)* | 0.25 ± 0.03 | 0.45 ± 0.03 | 8.0 ± 0.3 | 3.5 ± 0.05 | 1.75 ± 0.1 | 2.0 ± 0.05 | - | 4.0 ± 0.1 | 1.5 ± 0.1 | 8mm | Paper |

DETAIL OF LEADER AND TRAILER



ADHESIVE TAPE

1. The exfoliative strength when peeling off the top tape from the carrier tape by the method of the following figure shall be *0.1 to 0.5N.
2. When the top tape is peeled off, the adhesive stays on the top tape.
3. Chip capacitors will be in a state free without being stuck on the thermal adhesive tape.2



CARRIER TAPE

1. Chip will not fall off from carrier tape or carrier tape will not be damaged by bending than within a radius of 25mm.
2. The chip are inserted continuously without any empty pocket.
3. Chip will not be mis-mounted because of too big clearance between components and cavity. Also the waste of carrier tape will not fill a nozzle hole of mounting machine.

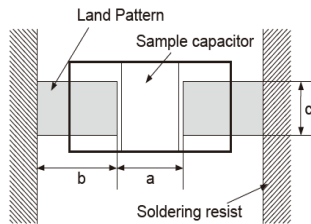
01005 MLCC Ultra Miniature Capacitors

Surface Mounting Information

DIMENSIONS FOR RECOMMENDED TYPICAL LAND

Since the amount of solder (size of fillet) to be used has direct influence on the capacitor after mounting, the sufficient consideration is necessary. When the amounts of solder is too much, the stress that a capacitor receives becomes larger. It may become the cause of a crack in the capacitor. When the land design of printed wiring board is considered, it is necessary to set up the form and size of land pattern so that the amount of solder is suitable.

(General)



GENERAL

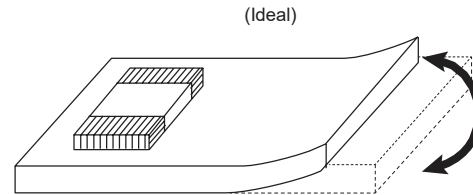
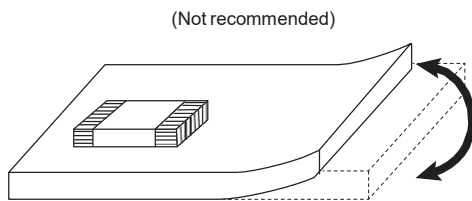
| "Size (EIA Code)" | Dimension | | Recommended Land Dimensions | | |
|-------------------|-----------|----------|-----------------------------|--------------|--------------|
| | L | W | a | b | c |
| 02 (01005) | 0.4±0.02 | 0.2±0.02 | 0.13 to 0.20 | 0.12 to 0.18 | 0.20 to 0.23 |

* Recommended land dimensions may differ depending on dimensional tolerance.

MOUNTING DESIGN

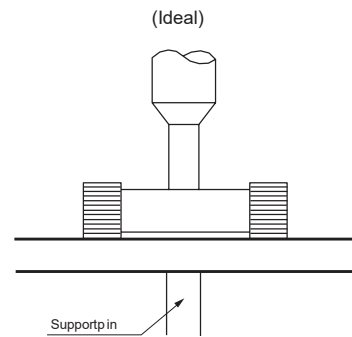
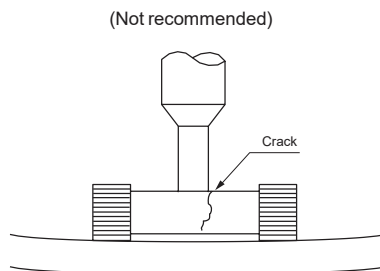
The chip could crack if the PCB warps during processing after the chip has been soldered.

RECOMMENDED CHIP POSITION ON PCB TO MINIMIZE STRESS FROM PCB WARPAGE



MOUNTING

1. If the position of the vacuum nozzle is too low, a large force may be applied to the chip capacitor during mounting, resulting in cracking.
2. During mounting, set the nozzle pressure to a static load of 1 to 3 N.
3. To minimize the shock of the vacuum nozzle, provide a support pin on the back of the PCB to minimize PCB flexure.



4. Bottom position of pick up nozzle should be adjusted to the top surface of a substrate when camber is corrected.

RESIN MOLD

1. If a large amount of resin is used for molding the chip, cracks may occur due to contraction stress during curing. To avoid such cracks, use a low shrinkage resin.
2. The insulation resistance of the chip will degrade due to moisture absorption. Use a low moisture absorption resin.
3. Check carefully that the resin does not generate a decomposition gas or reaction gas during the curing process or during normal storage. Such gases may crack the chip capacitor or damage the device itself.

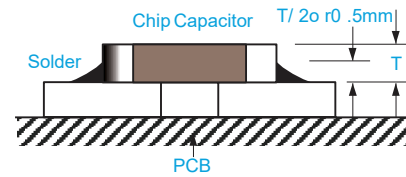
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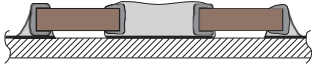
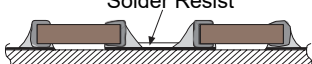
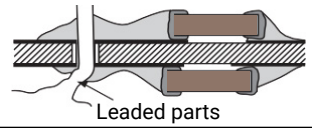
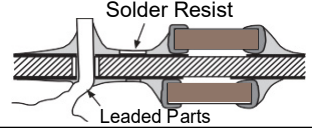
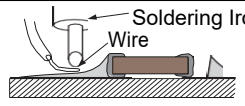
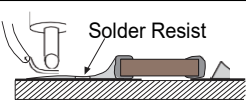
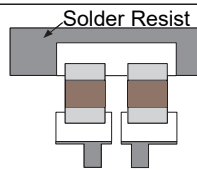
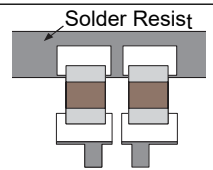
Surface Mounting Information

SOLDERING METHOD

The recommended fillet height shall be 1/2 of the thickness of capacitors or 0.5mm. When mounting two or more capacitors in the common land, it is necessary to separate the land with the solder resist strike so that it may become the exclusive land of each capacitor.

IDEAL SOLDER HEIGHT



| Item | Prohibited | Recommended example : Separation by solder resist |
|-------------------------------|--|--|
| Multiple parts mount |  |  |
| Mount with leaded parts |  |  |
| Wire soldering after mounting |  |  |
| Side by side layout |  |  |

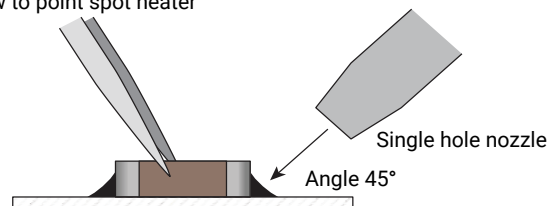
DESIGN OF PRINTED CIRCUIT AND SOLDERING

1. Ceramic is easily damaged by rapid heating or cooling. If some heat shock is unavoidable, preheat enough to limit the temperature difference (Delta T) to within 150 degree Celsius.
2. The product size 1.6×0.8mm to 3.2×1.6mm can be used in reflow and wave soldering, and the product size of bigger than 3.2×1.6mm, or smaller than 1.6×0.8mm can be used in reflow. Circuit shortage and smoking can be created by using capacitors which are used neglecting the above caution.
3. Please see our recommended soldering conditions.
4. In case of using Sn-Zn Solder, please contact us in advance.
5. The following condition is recommended for spot heater application.

RECOMMENDED SPOT HEATER CONDITION

| Item | Condition |
|------------------|-----------------------------|
| Distance | 5mm min. |
| Angle | 45° |
| Projection Temp. | 400°C max. |
| Flow Rate | Set at the minimum |
| Nozzle Diameter | 2φ to 4φ (Single hole type) |
| Application time | 10 sec max. |

How to point spot heater

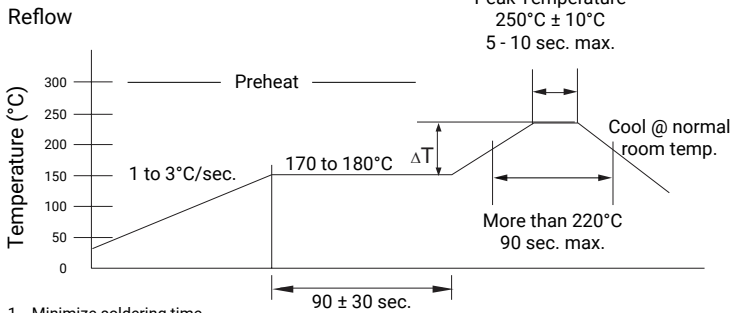


01005 MLCC Ultra Miniature Capacitors

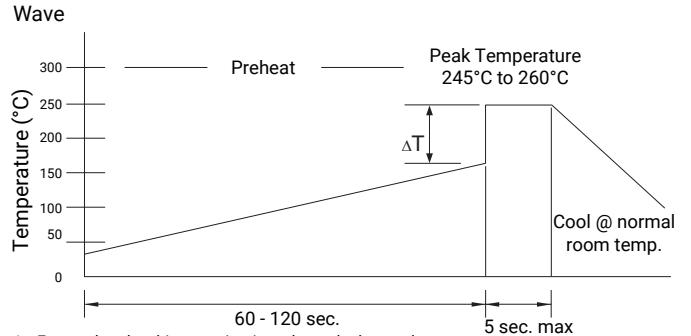
Surface Mounting Information



RECOMMENDED TEMPERATURE PROFILE (Sn-3Ag-0.5Cu)

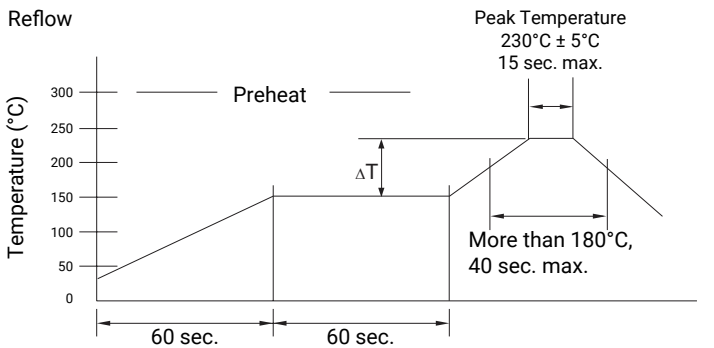


1. Minimize soldering time.
2. Ensure that allowable temperature difference does not exceed 150°C.
3. Ensure that allowable temperature difference does not exceed 130°C for 3.2x2.5mm size or larger.
4. MLCC can withstand the above reflow conditions up to 3times.
5. N₂atmosphere is recommended for reflow of products of 0.4mmx0.2mm size or smaller.

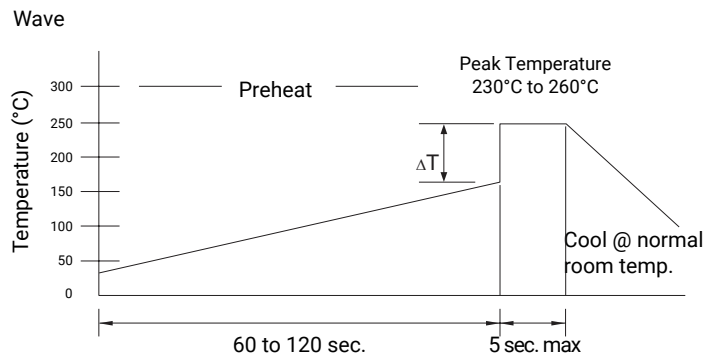


1. Ensure that the chip capacitor is preheated adequately.
2. Ensure that the temperature difference (ΔT) does not exceed 150°C.
3. Cool naturally after soldering. MLCC can withstand the above reflow conditions up to 3times.
4. Wave soldering is not applicable for chips with size of 3.2x2.5mm or larger of 1.0x0.5mm or smaller and capacitor arrays.

RECOMMENDED TEMPERATURE PROFILE (63n Solder)



1. Minimize soldering time.
2. Ensure that the temperature difference (ΔT) does not exceed 150°C.
3. Ensure that the temperature difference (ΔT) does not exceed 130°C for 3.2x2.5mm size or larger.
4. MLCC can withstand the above reflow conditions up to 3times.



1. Ensure that the chip capacitor is preheated adequately.
2. Ensure that the temperature difference (ΔT) does not exceed 150°C.
3. Cool naturally after soldering.
4. Wave soldering is not applicable for chips with size of 3.2x2.5mm or larger of 1.0x0.5mm or smaller and capacitor arrays.

Precautions

CIRCUIT DESIGN

1. Once application and assembly environments have been checked, the capacitor may be used in conformance with the rating and performance which are provided in both the catalog and the specifications. Use exceeding that which is specified may result in inferior performance or cause a short, open, smoking, or flaming to occur, etc.
2. Please consult the manufacturer in advance when the capacitor is used in devices such as: devices which deal with human life, i.e. medical devices; which are highly public orientated; and devices which demand a high standard of liability. Accident or malfunction of devices such as medical devices, space equipment and devices having to do with atomic power could generate grave consequence with respect to human lives or, possibly, a portion of the public. Capacitors used in these devices may require high reliability design different from that of general-purpose capacitors.
3. Please use the capacitors in conformance with the operating temperature provided in both the catalog and the specifications. Be especially cautious not to exceed the maximum temperature. In the situation the maximum temperature set forth in both the catalog and specifications is exceeded, the capacitor's insulation resistance may deteriorate, power may suddenly surge and short-circuit may occur. The capacitor has a loss and may self-heat due to equivalent series resistance when alternating electric current is passed there through. As this effect becomes especially pronounced in high frequency circuits, please exercise caution. When using the capacitor in a (self-heating) circuit, please make sure the surface of the capacitor remains under the maximum temperature for usage. Also, please make certain temperature rises remain below 20°C.
4. Please keep voltage under the rated voltage which is applied to the capacitor. Also, please make certain the peak voltage remains below the rated voltage when AC voltage is super-imposed to the DC voltage. In the situation where AC or pulse voltage is employed, ensure average peak voltage does not exceed the rated voltage. Exceeding the rated voltage provided in both catalog and specifications may lead to defective withstanding voltage or, in worst case situations, may cause the capacitor to smoke or flame.
5. When the capacitor is to be employed in a circuit in which there is continuous application of a high frequency voltage or a steep pulse voltage, even though it is within the rated voltage, please inquire to the manufacturer. In the situation the capacitor is to be employed using a high frequency AC voltage or an extremely fast rising pulse voltage, even though it is within the rated voltage, it is possible capacitor reliability will deteriorate.
6. It is a common phenomenon of high-dielectric products to have a deteriorated amount of static electricity due to the application of DC voltage. Due caution is necessary as the degree of deterioration varies depending on the quality of capacitor materials, capacity, as well as the load voltage at the time of operation.
7. Do not use the capacitor in an environment where it might easily exceed the respective provisions concerning shock and vibration specified in the catalog and specifications. In addition, it is a common piezo phenomenon of high dielectric products to have some voltage due to vibration or to have noise due to voltage change. Please contact sales in such case.
8. If the electrostatic capacity value of the delivered capacitor is within the specified tolerance, please consider this when designing the respective product in order that the assembled product function appropriately.
9. Please contact us upon using conductive adhesives.

STORAGE

1. If the component is stored in minimal packaging (a heat-sealed or zippered plastic bag), the bag should be kept closed. Once the bag has been opened, reseal it or store it in a desiccator.
2. Keep storage place temperature +5 to +40 °C, humidity 20 to 70% RH. See JIS C 6 0721-3-1, class 1K2 for other climatic conditions.
3. The storage atmosphere must be free of corrosive gas such as sulfur dioxide and chlorine. Also, avoid exposing the product to saline moisture. If the product is exposed to such atmospheres, the terminals will oxidize and solderability will be effected.
4. Precautions 1) to 3) apply to chip capacitors packaged in carrier tapes.
5. The solderability is assured for 6 months from our shipping date if the above storage precautions are followed.

01005 MLCC Ultra Miniature Capacitors

Part Number List



General CM02 Series Size (JIS Code): 01005(0402)# Packaging Code (Packaging quantity): H(20,000pcs.)

| Dielectric code CA | Capacitance | □:Tolerance | Voltage [V] | Part Number | Q | Dimension | | | # Packaging Code (quantity) | | |
|-----------------------|----------------------|---------------------------|-----------------|--------------------|-------------------|--------------------|------------|------------|--------------------------------|-----------|---|
| | | | | | | L [mm] | W [mm] | T [mm] | | | |
| CG | 1.0pF | B: ± 0.1pF C: ± 0.25pF | 25 | CM02C Δ 1R0 □ 25A# | 420 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 1.5pF | | | CM02C Δ 1R5 □ 25A# | 430 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 2.0pF | | | CM02C Δ 2R0 □ 25A# | 440 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 3.0pF | | | CM02C Δ 3R0 □ 25A# | 460 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 4.0pF | | | CM02C Δ 4R0 □ 25A# | 480 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 5.0pF | | | CM02C Δ 5R0 □ 25A# | 500 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 6.0pF | C: ± 0.25pF | 25 | CM02C Δ 6R0 □ 25A# | 520 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 7.0pF | | | CM02C Δ 7R0 □ 25A# | 540 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 8.0pF | | | CM02C Δ 8R0 □ 25A# | 560 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 9.0pF | | | CM02C Δ 9R0 □ 25A# | 580 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 10pF | | | CM02C Δ 100 □ 25A# | 600 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 12pF | | | J: ± 5% | 25 | CM02C Δ 120 □ 25A# | 640 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H |
| | 15pF | CM02C Δ 150 □ 25A# | 700 | | | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 18pF | CM02C Δ 180 □ 25A# | 760 | | | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 22pF | CM02C Δ 220 □ 25A# | 840 | | | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| | 27pF | J: ± 5% | 16 | | | CM02C Δ 270 □ 16A# | 940 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H |
| | 33pF | | | | | CM02C Δ 330 □ 16A# | 1000 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H |
| | 39pF | | | | | CM02C Δ 390 □ 16A# | 1000 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H |
| | 47pF | | | | | CM02C Δ 470 □ 16A# | 1000 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H |
| | 56pF | | | | | CM02C Δ 560 □ 16A# | 1000 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H |
| | 68pF | | | | | CM02C Δ 680 □ 16A# | 1000 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H |
| | 82pF | | | CM02C Δ 820 □ 16A# | 1000 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| 100pF | CM02C Δ 101 □ 16A# | | | 1000 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | | |
| 220pF | CM02C Δ 221 □ 16A# | | | 1000 | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | | |
| 100pF | K: ± 10% M: ± 20% | | | 16 | CM02X5R101 □ 16A# | 12.5 | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | |
| 150pF | | CM02X5R151 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 220pF | | CM02X5R221 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 330pF | | CM02X5R331 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 470pF | | CM02X5R471 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 680pF | | CM02X5R681 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 1000pF | | CM02X5R102 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 1500pF | | CM02X5R152 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 2200pF | | CM02X5R222 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 4700pF | | CM02X5R472 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 6800pF | | CM02X5R682 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 10000pF | | CM02X5R103 □ 16A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 15000pF | | CM02X5R153 □ 06A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 22000pF | | CM02X5R223 □ 06A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 33000pF | | CM02X5R333 □ 06A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 47000pF | | CM02X5R473 □ 06A# | 12.5 | | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| 0.10μF | | M: ± 20% | 10 | | CM02X5R104 □ 10A# | 12.5 | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | |
| 0.10μF | | K: ± 10% | 6.3 | | CM02X5R104 □ 06A# | 12.5 | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | |
| | M: ± 20% | | | | | | | | | | |
| 0.22μF | M: ± 20% | 6.3 | CM02X5R224M06A# | 12.5 | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| | | | CM02X5R474M06A# | 12.5 | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | | |
| X7R | 2200μF | K: ± 10% | 16 | CM02X7R222 □ 16A# | 12.5 | 0.4 ± 0.02 | 0.2 ± 0.02 | 0.2 ± 0.02 | H | | |
| | | M: ± 20% | | | | | | | | | |

01005 MLCC Ultra Miniature Capacitors

Part Number List



General CM02 Series Size (JIS Code): 01005(0402)# Packaging Code (Packaging quantity): H(20,000pcs.)

| Dielectric code CΔ | Capacitance | □:Tolerance | Voltage [V] | Part Number | Dimension | | | # Packaging Code (quantity) | |
|-----------------------|--------------------|------------------------------|--------------------|--------------------|--------------------|-----------|-----------|--------------------------------|---|
| | | | | | L [mm] | W [mm] | T [mm] | | |
| CG | R50 | C: ± 0.25pF | 25 | CU02C Δ R50 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 1.0pF | | | CU02C Δ 1R0 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 1.5pF | | | CU02C Δ 1R5 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 2.0pF | | | CU02C Δ 2R0 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 3.0pF | | | CU02C Δ 3R0 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 4.0pF | | | CU02C Δ 4R0 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 5.0pF | | | CU02C Δ 5R0 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 6.0pF | | | CU02C Δ 6R0 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 7.0pF | | | CU02C Δ 7R0 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 8.0pF | | | CU02C Δ 8R0 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 9.0pF | CU02C Δ 9R0 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | | |
| | 10pF | J: ± 5% | 25 | CU02C Δ 100 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 12pF | | | CU02C Δ 120 □ 25AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | R20 | "B: ± 0.1pF C: ± 0.25pF " | 16 | CU02C Δ R20 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | R50 | | | CU02C Δ R50 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 1R0 | | | CU02C Δ 1R0 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 1R5 | | | CU02C Δ 1R5 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 2R0 | | | CU02C Δ 2R0 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 3R0 | | | CU02C Δ 3R0 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| | 4R0 | | | CU02C Δ 4R0 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | |
| 5R0 | CU02C Δ 5R0 □ 16AH | | | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| 6R0 | C: ± 0.25pF | 16 | CU02C Δ 6R0 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| 7R0 | | | CU02C Δ 7R0 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| 8R0 | | | CU02C Δ 8R0 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| 9R0 | | | CU02C Δ 9R0 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H | | |
| 10pF | | | J: ± 5% | 16 | CU02C Δ 100 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H |
| 12pF | | | | | CU02C Δ 120 □ 16AH | 0.4± 0.02 | 0.2± 0.02 | 0.2± 0.02 | H |
| 15pF | CU02C Δ 150 □ 16AH | 0.4± 0.02 | | | 0.2± 0.02 | 0.2± 0.02 | H | | |
| 18pF | CU02C Δ 180 □ 16AH | 0.4± 0.02 | | | 0.2± 0.02 | 0.2± 0.02 | H | | |
| 22pF | CU02C Δ 220 □ 16AH | 0.4± 0.02 | | | 0.2± 0.02 | 0.2± 0.02 | H | | |

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